

REV.	Q'TY	ECN. NO.	APR.	DATE

序号	品名	材质
①	0.8 Pitch D型 浮动式立式BTB公座触点	PA10T UL94 V-0,颜色:黑色
②	0.8 Pitch D型 浮动式立式BTB公座端子	铜合金/表面镀金
③	0.8 Pitch D型 浮动式立式BTB公座弹片	铜合金/表面镀锡
④	0.8 Pitch D型 浮动式立式BTB公座侧盖	LCP 130i UL94 V-0,颜色:黑色

0.8 浮动式 SMT 板对板高配合情况

合高 每座单高	公座单高	4.8	6.8
	8.5	9.75	11.75

浮动式板对板支持X.Y.Z方向±0.5的摆动

Part No	CKT	A	B	C	D	E
XY-DF868D-30LBGDH	2X15	11.20	13.00	14.40	16.30	11.20
XY-DF868D-40LBGDH	2X20	15.20	17.00	18.40	20.30	15.20
XY-DF868D-50LBGDH	2X25	19.20	21.00	22.40	24.30	19.20
XY-DF868D-60LBGDH	2X30	23.20	25.00	26.40	28.30	23.20
XY-DF868D-70LBGDH	2X35	27.20	29.00	30.40	32.30	27.20
XY-DF868D-80LBGDH	2X40	31.20	33.00	34.40	36.30	31.20
XY-DF868D-90LBGDH	2X45	35.20	37.00	38.40	40.30	35.20
XY-DF868D-100LBGDH	2X50	39.20	41.00	42.40	44.30	39.20
XY-DF868D-110LBGDH	2X55	43.20	45.00	46.40	48.30	43.20
XY-DF868D-120LBGDH	2X60	47.20	49.00	50.40	52.30	47.20

DIMENSION IN mm

TOLERANCE UNLESS
OTHERWISE SPECIFIED

.X±0.5	X.*± 1°	APR.	Alex
.XX±0.2	.X.*±	CHK.	Jack
.XXX±0.1	.XX.*±	DRA.	Can

厦门市辛译精密电子有限公司
Xiamen XinYi Xyeconn Electronics Co.,Ltd

TITLE: 0.8 Pitch D型浮动式立式BTB公座侧盖(料号6.8)

DWG NO. XY-DF868D-NLBGDH

PROJ. 

CUSTOMER DRAWING

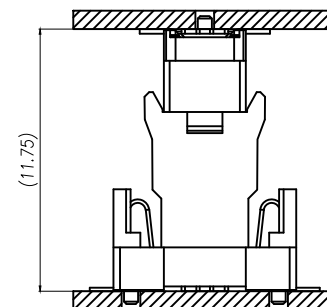
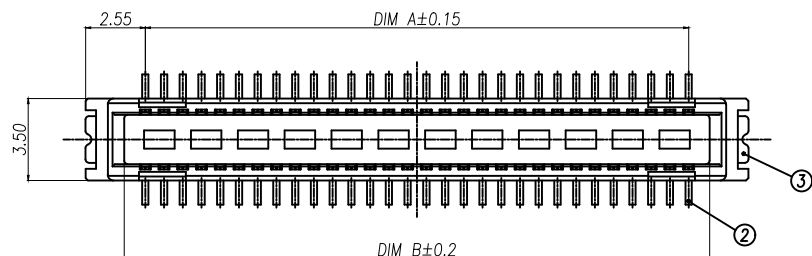
SIZE A4

SCALE 1:1

SHEET 1/1

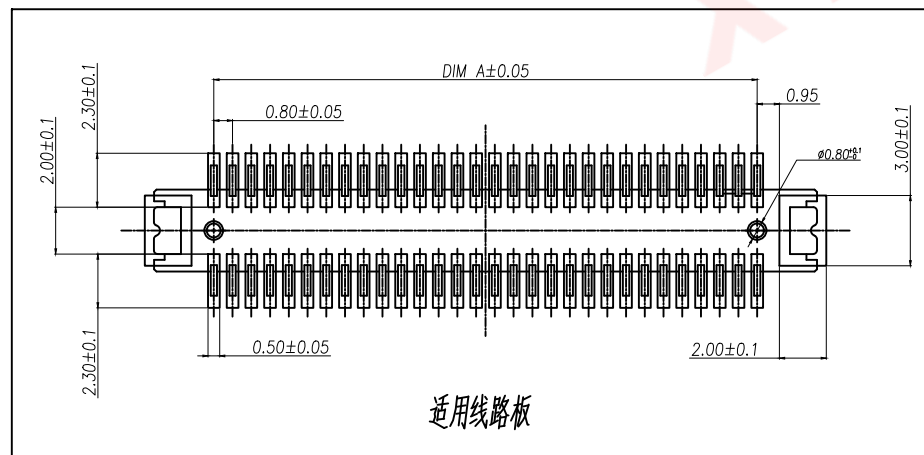
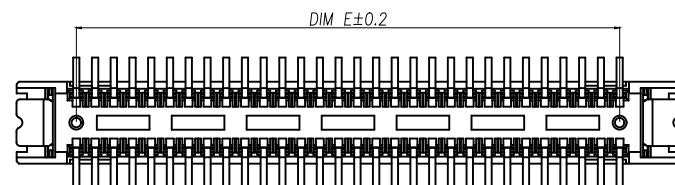
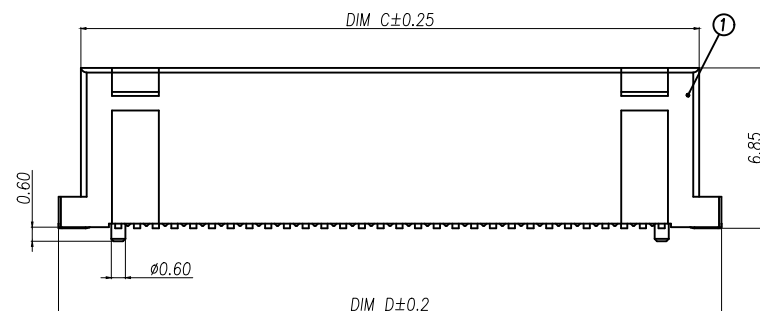
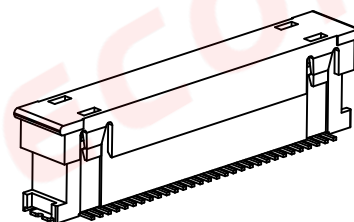
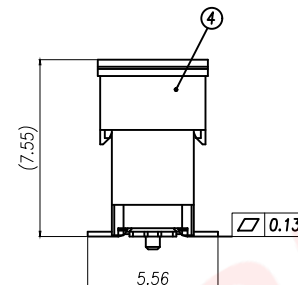
REV. A

F-RD-18A



技术指标:

1. 塑件表面应光洁、无毛边、无明显收缩、缺陷、裂纹等现象。
2. 温度范围: -40°C~85°C.
3. 额定电压: 50V, AC.
4. 接触电阻: <0.1Ω.
5. 绝缘电阻: ≥500MΩ



适用线路板